



Sheet 1 of 1

Form 1449*

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use several sheets if necessary)

Applicant: Kie Y. Ahn et al.

Filing Date: March 26, 2001 Group: Unknown

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^{**}EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of these form with next communication to applicant.